



Product Change Notification

Change Notification #: 115929 - 00
Change Title: Intel® SSD DC P4510 Series,
SSDPE2KX010T801, MM#959391,
SSDPE2KX010T810, MM# 959392,
SSDPE2KX020T801, MM#959393 and
SSDPE2KX020T810, MM#959394,
PCN 115929-00, Label

Date of Publication: November 21, 2017

Key Characteristics of the Change:

Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Dec 07, 2017
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Description of Change to the Customer:

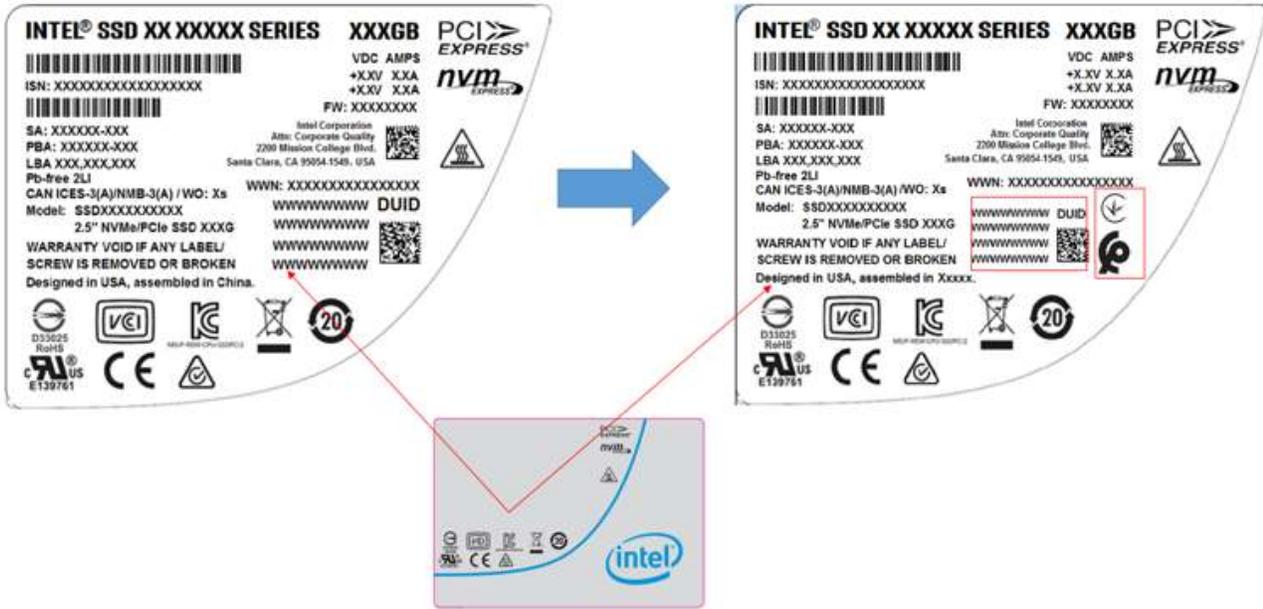
The Intel® SSD DC P4510 Series skus listed in the Products Affected Table below will have the following change:

The regulatory label will be updated to include BSMI ROHS for countries Morocco and Ukraine and decrease the DUID size value on the label. See picture below.

- 1) Add Morocco logo and Ukraine logo
- 2) Reduce the DUID size

Current:

To Be:



Customer Impact of Change and Recommended Action:

There is no change to the Form, Fit, or Function of the product. The change is only to the labels used in packaging.

Customers should be aware of the changes to the label and take appropriate actions to accommodate the changes and avoid impact to their process.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#
Intel® SSD DC P4510 Series	SSDPE2KX010T801	959391
Intel® SSD DC P4510 Series	SSDPE2KX010T810	959392
Intel® SSD DC P4510 Series	SSDPE2KX020T801	959393
Intel® SSD DC P4510 Series	SSDPE2KX020T810	959394

PCN Revision History:

Date of Revision:

November 21, 2017

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apagccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

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